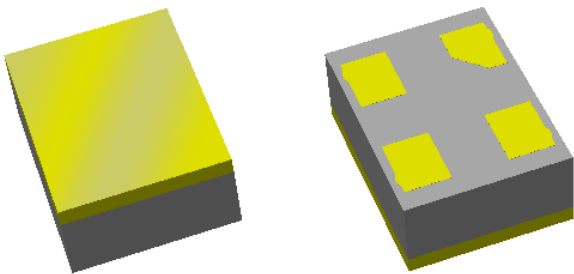


Features

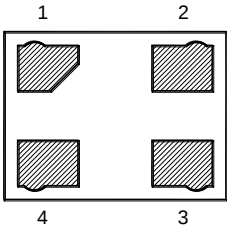
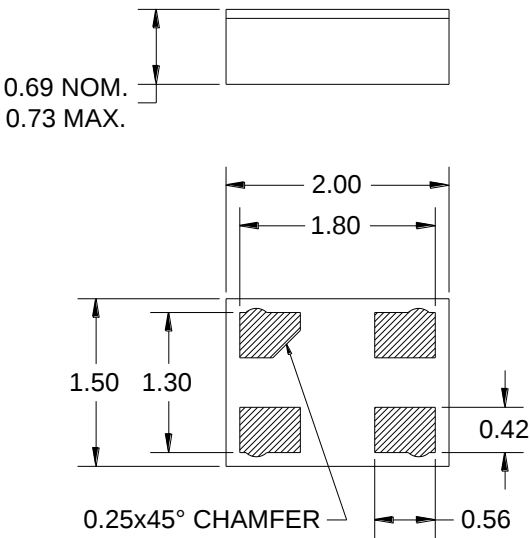
- For ISM Band applications
- Usable bandwidth 10 MHz
- Low loss
- Single-ended operation
- Chip Scale Package (CSP)
- Hermetic
- **RoHS** compliant (2002/95/EC), **Pb-free** 



Package **Pin Configuration**

Surface Mount 2.00 x 1.50 x 0.69 mm
CSP-8A

Bottom View



Pin No.	Description
1	Input
3	Output
2,4	Case ground

Dimensions shown are nominal in millimeters
All tolerances are $\pm 0.10\text{mm}$

Body: Al_2O_3 ceramic
Lid: Kovar or Alloy 42, Au over Ni plated
Terminations: Au plating 0.5 - 1.0 μm ,
over a 2 - 6 μm Ni plating

Electrical Specifications ⁽¹⁾

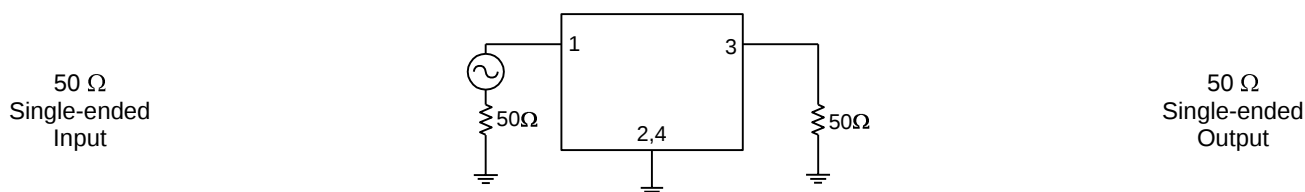
Operating Temperature Range: ⁽²⁾ -40°C to +85 °C

Parameter ⁽³⁾	Minimum	Typical ⁽⁴⁾	Maximum	Unit
Center Frequency	-	875	-	MHz
Maximum Insertion Loss 870 – 880 MHz	-	1.8	3	dB
Absolute Attenuation ⁽⁵⁾				
10 – 810 MHz	40	52	-	dB
810 – 848 MHz	35	42	-	dB
924 – 960 MHz	35	48	-	dB
960 – 1110 MHz	40	52	-	dB
1110 – 3000 MHz	30	39	-	dB
Amplitude Variation 870 – 880 MHz	-	0.15	1.0	dB p-p
Group Delay Variation 870 – 880 MHz	-	8	50	ns p-p
Input/Output Return Loss 870 – 880 MHz	10	14	-	dB
Source Impedance (single-ended) ⁽⁶⁾	-	50	-	Ω
Load Impedance (single-ended) ⁽⁶⁾	-	50	-	Ω

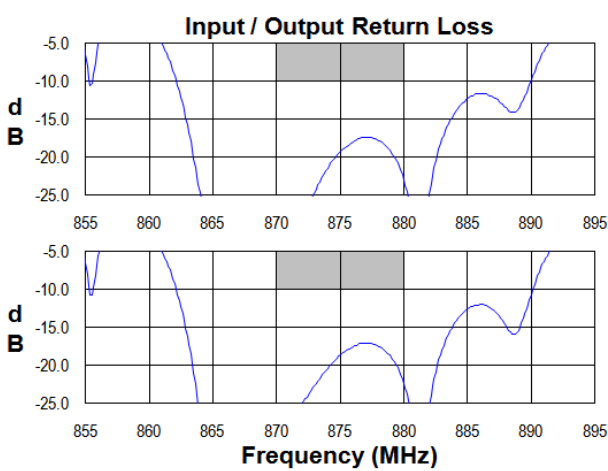
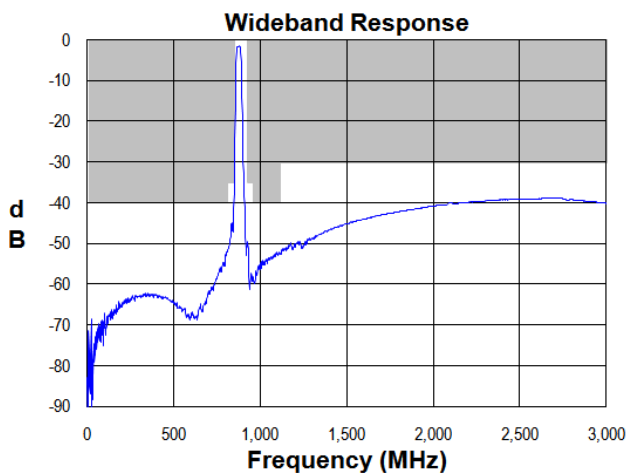
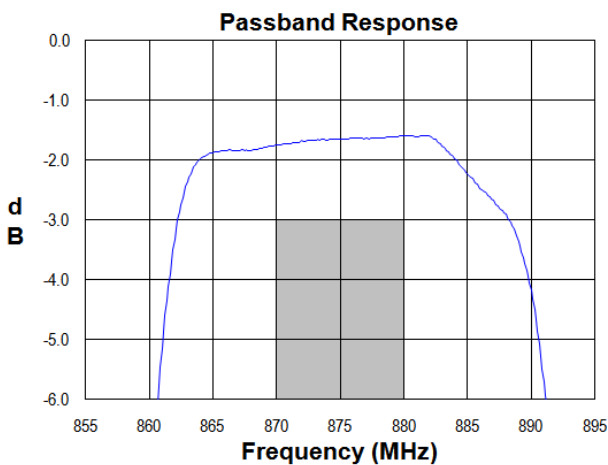
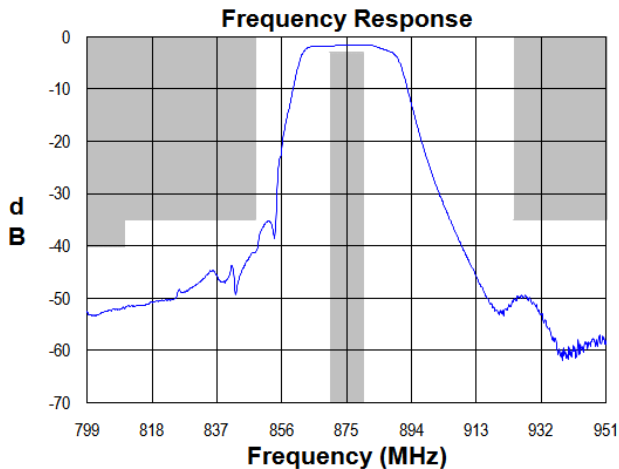
Notes:

1. All specifications are based on the test circuit below
2. In production, devices will be tested at room temperature to a guardbanded specification to ensure electrical compliance over temperature
3. Electrical margin has been built into the design to account for the variations due to temperature drift and manufacturing tolerances
4. Typical values are based on average measurements at room temperature
5. Relative to zero dB
6. This is the optimum impedance in order to achieve the performance

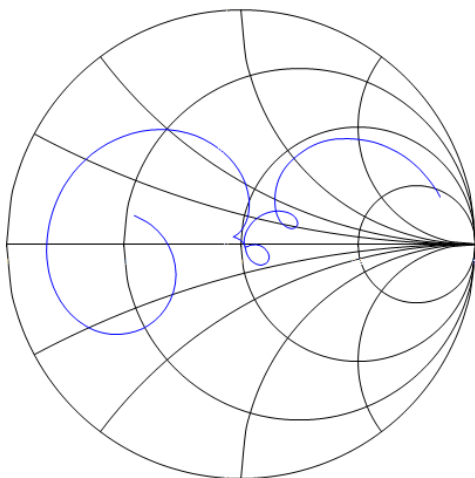
Test Circuit:



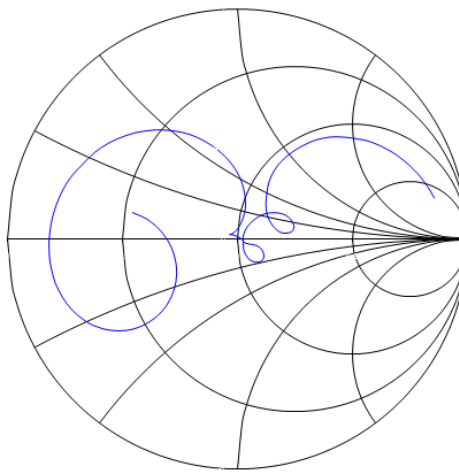
Typical Performance (at room temperature)



Input Smith Chart

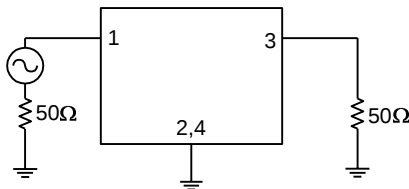


Output Smith Chart



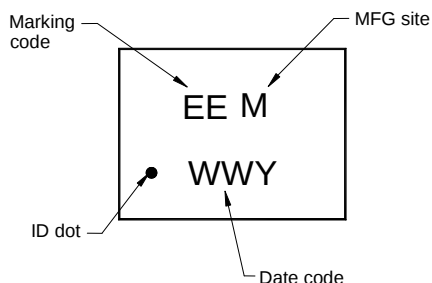
Matching Schematics

50 Ω
Single-ended
Input



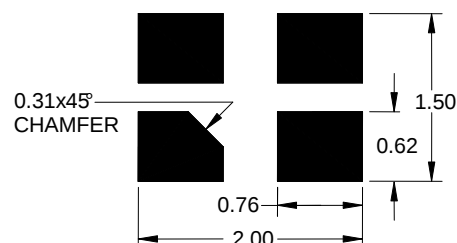
50 Ω
Single-ended
Output

Marking



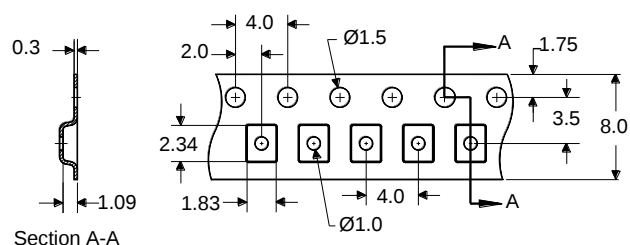
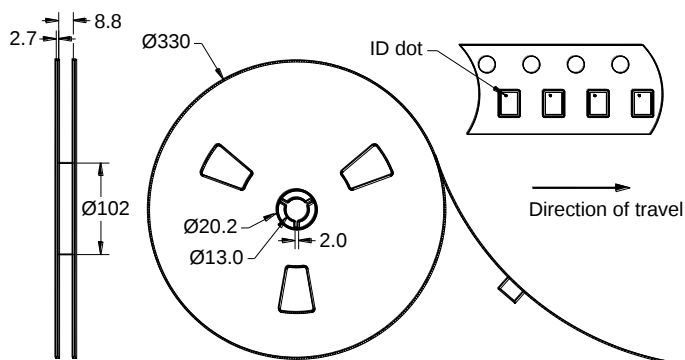
The date code consists of: WW = 2 digit week,
Y = last digit of year, M = manufacturing site code

PCB Footprint



This footprint represents a recommendation only
Dimensions shown are nominal in millimeters

Tape and Reel



Dimensions shown are nominal in millimeters
Packaging quantity: 10000 units/reel

Maximum Ratings

Parameter	Symbol	Minimum	Maximum	Unit
Operating Temperature Range	T	-40	+85	°C
Storage Temperature Range	T _{stg}	-40	+85	°C

Important Notes

Warnings

- Electrostatic Sensitive Device (ESD)
- Avoid ultrasonic exposure



RoHS Compliance

- This product complies with EU directive 2002/95/EC (RoHS)



Solderability

- Compatible with JEDEC J-STD-020C **Pb**-free process, **260°C** peak reflow temperature ([see soldering profile](#))

Links to Additional Technical Information

[PCB Layout Tips](#)

[Qualification Flowchart](#)

[Soldering Profile](#)

[S-Parameters](#)

[RoHS Information](#)

[Other Technical Information](#)

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[Representatives or distributors](#)